STEIFPOWER TECHNOLOGY

30V N+P Dual Channel MOSFETs

SPC3712L

General Description

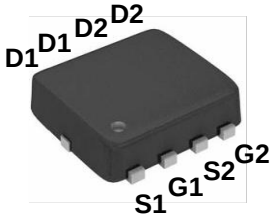
These N+P dual Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

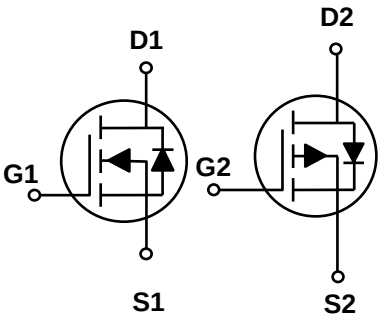
BVDSS	RDSON	ID
30V	20mΩ	12A
-30V	50mΩ	-8A

Features

- *Fast switching*
- *Green Device Available*
- *Suit for 4.5V Gate Drive Applications*

PPAK3X3 Dual NEP Pin Configuration





Applications

- *DC Fan*
- *Motor Drive Applications*
- *Networking*
- *Half / Full Bridge Topology*

RoHS COMPLIANT

Absolute Maximum Ratings Tc=25℃ unless otherwise noted

Symbol	Parameter	Rating		Units
V_{DS}	Drain-Source Voltage	30	-30	V
V_{GS}	Gate-Source Voltage	±20	±20	V
I_D	Drain Current – Continuous (T_C=25℃)	12	-8	A
	Drain Current – Continuous (T_C=100℃)	7.2	-4.8	A
I_{DM}	Drain Current – Pulsed[1]	48	-32	A
EAS	Single Pulse Avalanche Energy[2,6]	14	5	mJ
IAS	Single Pulse Avalanched Current[2]	17	10	A
P_D	Power Dissipation (T_C=25℃)	20		W
	Power Dissipation – Derate above 25℃	0.16		W/℃
T_{STG}	Storage Temperature Range	-55 to 150		℃
T_J	Operating Junction Temperature Range	-55 to 150		℃

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	62.5	℃/W
$R_{\theta JC}$	Thermal Resistance Junction to Case	---	6.4	℃/W

N-CH Electrical Characteristics (T_J=25 ℃, unless otherwise)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V , I_D=250uA	30	---	---	V
I_{DSS}	Drain-Source Leakage Current	V_{DS}=30V , V_{GS}=0V , T_J=25℃	---	---	1	uA
		V_{DS}=24V , V_{GS}=0V , T_J=125℃	---	---	10	uA
I_{GSS}	Gate-Source Leakage Current	V_{GS}=±20V , V_{DS}=0V	---	---	±100	nA

On Characteristics

$R_{DS(ON)}$	Static Drain-Source On-Resistance	V_{GS}=10V , I_D=10A	---	15	20	mΩ
		V_{GS}=4.5V , I_D=6A	---	21	30	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS}=V_{DS} , I_D =250uA	1.2	1.5	2.5	V
$\Delta V_{GS(th)}$	$V_{GS(th)}$ Temperature Coefficient		---	-4	---	mV/℃
gfs	Forward Transconductance	V_{DS}=5V , I_D=6A	---	13	---	S

Dynamic and switching Characteristics

Q_g	Total Gate Charge[3,4]	V_{DS}=15V , V_{GS}=4.5V , I_D=8A	---	4.1	6	nC
Q_{gs}	Gate-Source Charge[3,4]		---	1	1.4	
Q_{gd}	Gate-Drain Charge[3,4]		---	2.1	4	
$T_{d(on)}$	Turn-On Delay Time[3,4]	V_{DD}=15V , V_{GS}=10V , R_G=6Ω I_D=1A	---	2.8	5	ns
T_r	Rise Time[3,4]		---	7.2	14	
$T_{d(off)}$	Turn-Off Delay Time[3,4]		---	15.8	30	
T_f	Fall Time[3,4]		---	4.6	9	
C_{iss}	Input Capacitance	V_{DS}=25V , V_{GS}=0V , F=1MHz	---	345	500	pF
C_{oss}	Output Capacitance		---	55	80	
C_{rss}	Reverse Transfer Capacitance		---	32	55	
Rg	Gate resistance	V_{GS}=0V, V_{DS}=0V, F=1MHz	---	3.2	6.4	Ω

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Source Current	V_G=V_D=0V , Force Current	---	---	12	A
I_{SM}	Pulsed Source Current		---	---	24	A
V_{SD}	Diode Forward Voltage	V_{GS}=0V , I_S=1A , T_J=25℃	---	---	1	V

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. V_{DD}=25V,V_{GS}=10V,L=0.1mH,I_{AS}=17A.,R_G=25Ω, Starting T_J=25℃.
3. The data tested by pulsed , pulse width ≦ 300us , duty cycle ≦ 2%.
4. Essentially independent of operating temperature.

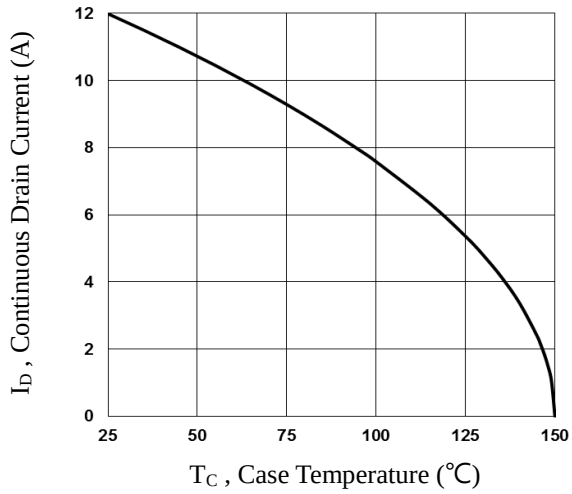


Fig.1 Continuous Drain Current vs. T_C

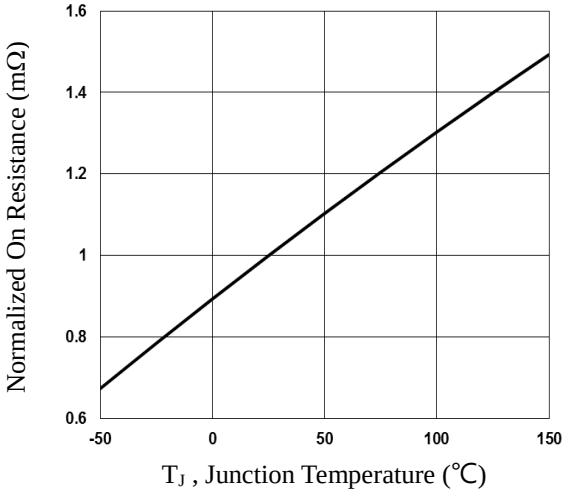


Fig.2 Normalized RDSON vs. T_J

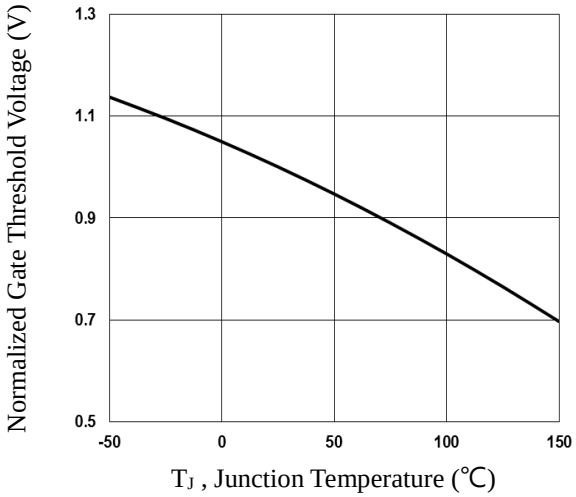


Fig.3 Normalized V_{th} vs. T_J

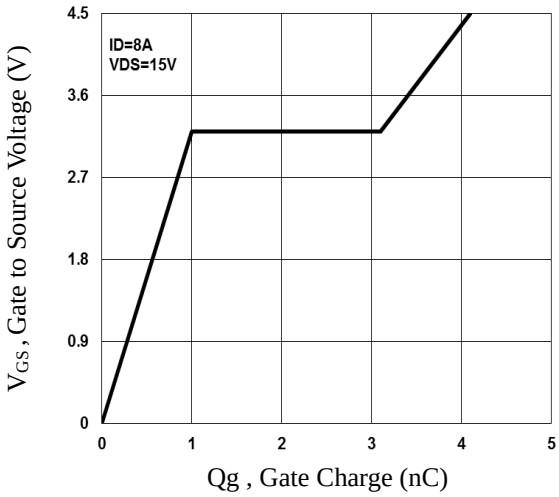


Fig.4 Gate Charge Waveform

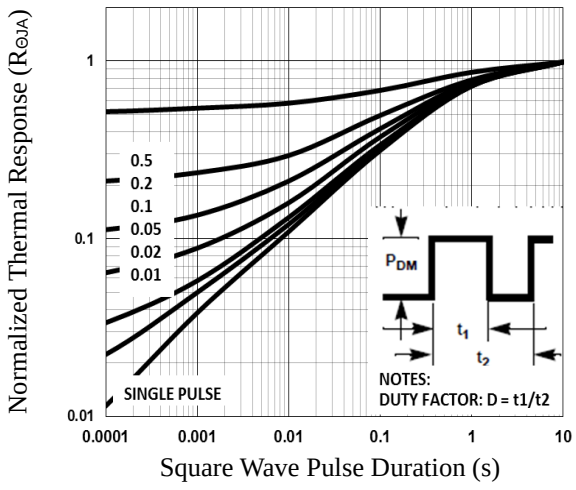


Fig.5 Normalized Transient Response

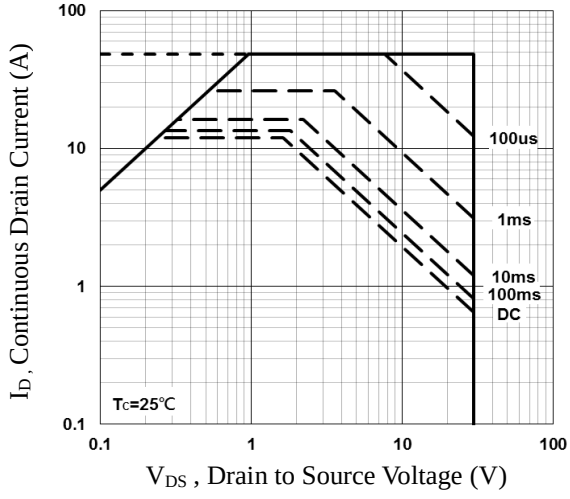


Fig.6 Maximum Safe Operation Area

P-CH Electrical Characteristics (T_J=25 ℃, unless otherwise

Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V , I_D=-250uA	-30	---	---	V
$\triangle BV_{DSS}/\triangle T_J$	BV_{DSS} Temperature Coefficient	Reference to 25℃ , I_D=-1mA	---	-0.03	---	V/℃
I_{DSS}	Drain-Source Leakage Current	V_{DS}=-30V , V_{GS}=0V , T_J=25℃	---	---	-1	uA
		V_{DS}=-24V , V_{GS}=0V , T_J=125℃	---	---	-10	uA
I_{GSS}	Gate-Source Leakage Current	V_{GS}=±20V , V_{DS}=0V	---	---	±100	nA

On Characteristics

$R_{DS(ON)}$	Static Drain-Source On-Resistance	V_{GS}=-10V , I_D=-5A	---	40	50	mΩ
		V_{GS}=-4.5V , I_D=-3A	---	60	75	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS}=V_{DS} , I_D =-250uA	-1.2	-1.6	-2.5	V
$\triangle V_{GS(th)}$	$V_{GS(th)}$ Temperature Coefficient		---	4	---	mV/℃
gfs	Forward Transconductance	V_{DS}=-10V , I_D=-3A	---	3.5	---	S

Dynamic and switching Characteristics

Q_g	Total Gate Charge[7,8]	V_{DS}=-15V , V_{GS}=-4.5V , I_D=-3A	---	5.1	7	nC
Q_{gs}	Gate-Source Charge[7,8]		---	2	3	
Q_{gd}	Gate-Drain Charge[7,8]		---	2.2	4	
$T_{d(on)}$	Turn-On Delay Time[7,8]	V_{DD}=-15V , V_{GS}=-10V , R_G=6Ω I_D=-1A	---	3.4	6	ns
T_r	Rise Time[7,8]		---	10.8	21	
$T_{d(off)}$	Turn-Off Delay Time[7,8]		---	26.9	51	
T_f	Fall Time[7,8]		---	6.9	13	
C_{iss}	Input Capacitance	V_{DS}=-15V , V_{GS}=0V , F=1MHz	---	560	810	pF
C_{oss}	Output Capacitance		---	55	80	
C_{rss}	Reverse Transfer Capacitance		---	40	60	

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Source Current	V_G=V_D=0V , Force Current	---	---	-8	A
I_{SM}	Pulsed Source Current		---	---	-16	A
V_{SD}	Diode Forward Voltage	V_{GS}=0V , I_S=-1A , T_J=25℃	---	---	-1	V

Note :

5. Repetitive Rating : Pulsed width limited by maximum junction temperature.
6. V_{DD}=-25V,V_{GS}=-10V,L=0.1mH,I_{AS}=-10A.,R_G=25Ω, Starting T_J=25℃
7. The data tested by pulsed , pulse width ≦ 300us , duty cycle ≦ 2%.
8. Essentially independent of operating temperature.

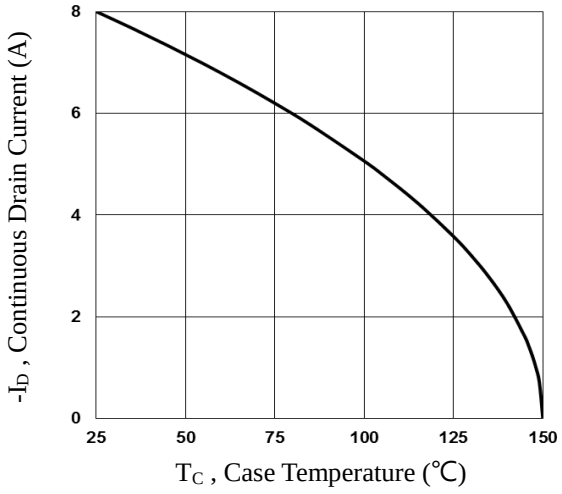


Fig.1 Continuous Drain Current vs. T_C

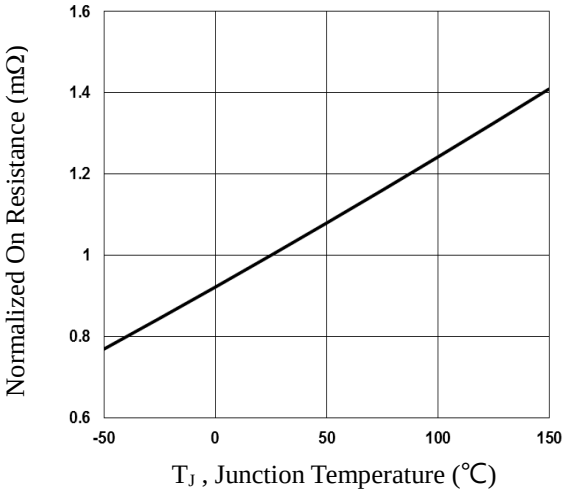


Fig.2 Normalized RDSON vs. T_J

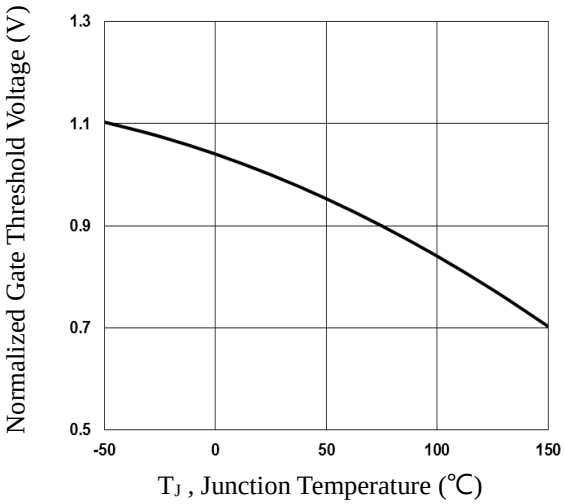


Fig.3 Normalized V_{th} vs. T_J

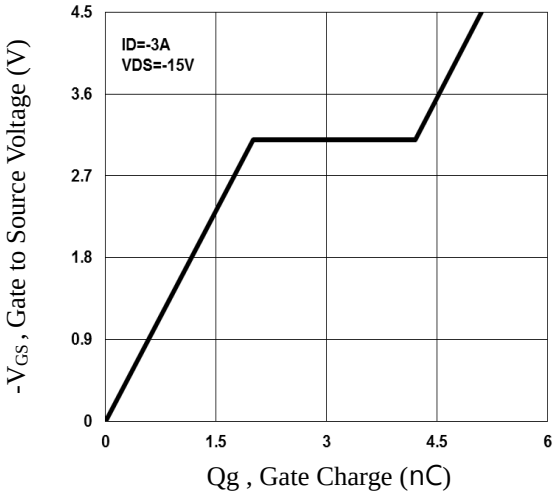


Fig.4 Gate Charge Waveform

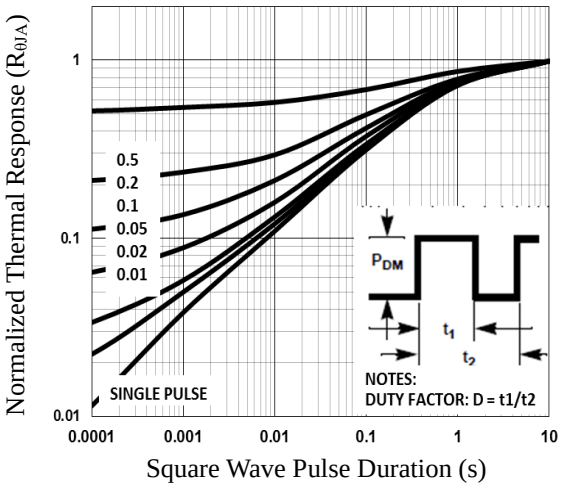


Fig.5 Normalized Transient Impedance

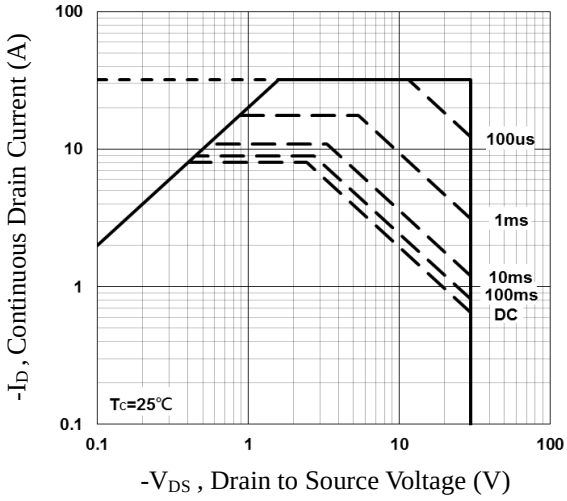


Fig.6 Maximum Safe Operation Area

PPAK3x3 Dual NEP PACKAGE INFORMATION